



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Nathan R. Brown

**Serial No.:** 10/715,267

**Filed:** November 17, 2003

**For:** METHODS FOR POLISHING  
SEMICONDUCTOR DEVICE  
STRUCTURES BY DIFFERENTIALLY  
APPLYING PRESSURE TO SUBSTRATES  
THAT CARRY THE SEMICONDUCTOR  
DEVICE STRUCTURES

**Confirmation No.:** 4590

**Examiner:** S. Macarthur

**Group Art Unit:** 1763

**Attorney Docket No.:** 2269-4375.1US  
(99-1029.01US)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

January 5, 2006  
Date

Signature

Erika Gandre

Name (Type/Print)

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This Amendment is being filed following the rejections presented in the Office Action mailed on October 5, 2005, the three-month shortened statutory period for response to which expires on January 5, 2005.

A listing of the claims, in which amendments to the claims are presented, starts at page 2 of this paper; and

Remarks begin on page 7 of this paper.